

NO.EA-155-070919

OUTLINE

The RP500X Series are CMOS-based step-down DC/DC Converters with synchronous rectifier.

Each of these ICs consists of an oscillator, a switching control circuit, a reference voltage unit, an error amplifier, a soft-start circuit, protection circuits, UVLO circuit, switching transistors, and so on. A low ripple, high efficiency step-down DC/DC converter can be easily composed of this IC with only an inductor and capacitors. In terms of the output voltage, since the feedback resistances are built-in, the voltage is fixed internally. 50mV(custom-made) step output can be set by laser-trim and 1.5% or 24mV tolerance depending on the output voltage is guaranteed.

Mode alternative circuit works automatically for improving the efficiency. Considering fixed noise frequency, PWM fixed control type is also available. As protection circuits, the current limit circuit which limits peak current of Lx at each clock cycle, and the latch type protection circuit which works if the term of the over-current condition keeps on a certain time exist. The latch-type protection circuit works to latch an internal driver with keeping it disable. To release the condition of the protection, after disabling this IC with a chip enable circuit, enable it again, or restart this IC with power-on or make the supply voltage at UVLO detector threshold level or lower than UVLO.

Since packages are PLP1820-6, SOT23-6, WLCSP-6 (0.16φ), high density mounting on boards is possible.

FEATURES

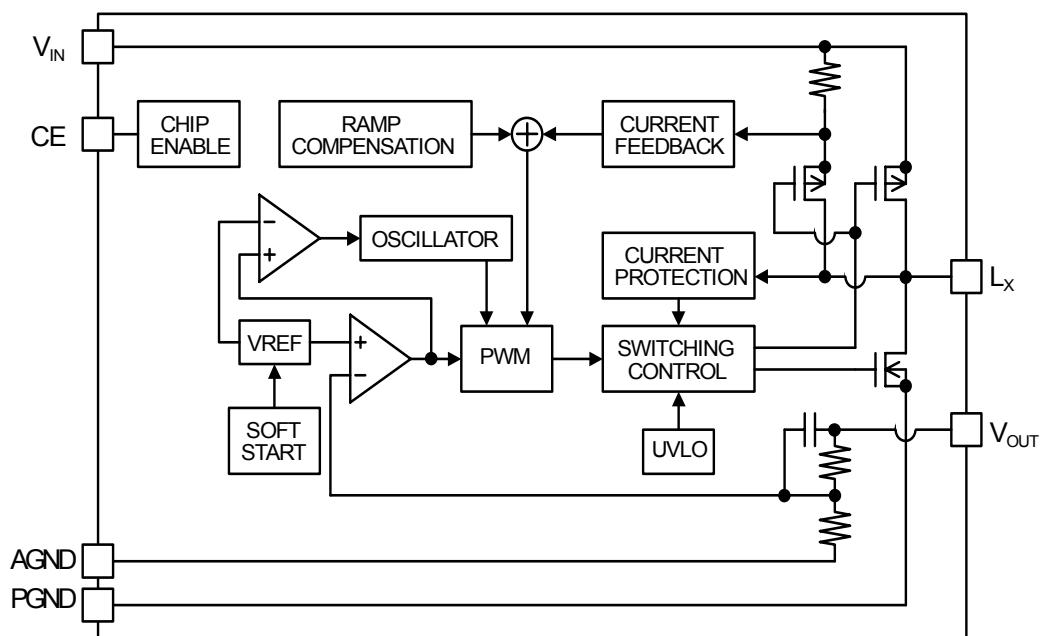
- Output Current..... Min. 400mA
- Input Voltage Range..... 2.55V to 5.50V
- Output Voltage..... 1.1V to 3.3V
- High Accuracy Output Voltage $\pm 1.5\%$ ($V_{out} \geq 1.6V$)
 $\pm 24mV$ ($V_{out} < 1.6V$)
- Oscillator Frequency..... Typ. 1.2MHz/3.3MHz(We changed the product name of 3.3MHz device.)
- Built-in Soft start Function..... Typ. 0.1ms
- Built-in Lx Peak Current Limit..... Typ. 900mA
- Built-in Latch type Protection..... Typ. 1.5ms
- Built-in UVLO Function..... Typ. 2.2V
- Two choices of Switching Mode..... Automatic PWM/PFM mode change / PWM fixed
- Packages..... PLP1820-6, SOT23-6W, WLCSP-6 (0.16φ)

APPLICATIONS

- Power source for portable equipment such as cellular, PDA, DSC, Notebook PC
- Power source for HDD
- Power source for Li-ion battery-used equipment

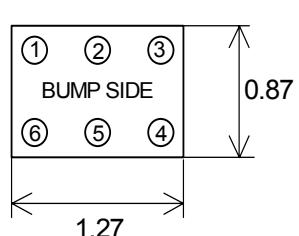
RP500X

BLOCK DIAGRAM

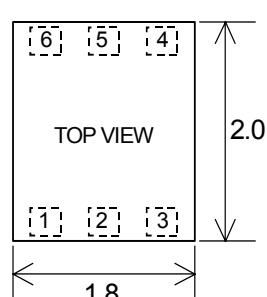


PIN CONFIGURATION

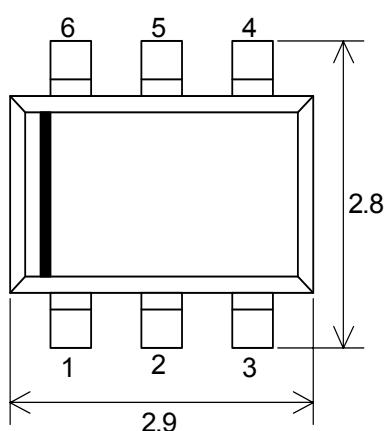
WL-CSP-6 (Under Development)



PLP-1820-6



SOT-23-6W



PIN DESCRIPTIONS**WLCSP-6 / SOT-23-6W**

Pin No.	Symbol	Pin Description
1	Vout	Output
2	PGND	Ground
3	Lx	Lx Switching
4	VIN	Voltage Supply
5	AGND	Ground
6	CE	Chip Enable (High Active)

PLP-1820-6

Pin No.	Symbol	Pin Description
1	CE	Chip Enable (High Active)
2	AGND	Ground
3	VIN	Voltage Supply
4	Lx	Lx Switching
5	PGND	Ground
6	VOUT	Output

ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Rating		Unit
Vin Supply Voltage	VIN	6.5		V
Lx Pin Voltage	VLX	-0.3 to VIN+0.3		V
CE Pin Input Voltage	VCE	-0.3 to VIN+0.3		V
Vout Pin Voltage	VOUT	-0.3 to VIN+0.3		V
Lx Pin Output Current	ILX	800		mA
Power Dissipation	PD	PLP	880	mW
		SOT	430	
		WLCSP	T.B.D.	
Operating Temp. Range	Topt	-40 to 85		°C
Storage Temp. Range	Tstg	-55 to 125		°C

Selection Guide

In the RP500 series, output voltage, function options, etc. can be designated with user's request.

Part number can be designated as follows:

RP500Xxxxx-XX Part Number

a b c d e

Code	Contents
a	Designation of the package K: PLP-1820-6 N: SOT-23-6W Z: WL-CSP-6 (Under Development)
b	Designation of output voltage Designation is possible in the range from 1.1V to 3.3V with a step of 0.1V
c	Designation of the function (with or without PWM/PFM Alternative function, auto discharge function) 1:with PWM/PFM alternative, without auto discharge 2:without PWM/PFM alternative, without auto discharge 4:without PWM/PFM alternative function, with auto discharge function
d	Frequency A: 1.2MHz
e	Designation of the taping type: (-TR is the standard.)

* 0.05V step is also available as a custom code.

ELECTRICAL CHARACTERISTICS

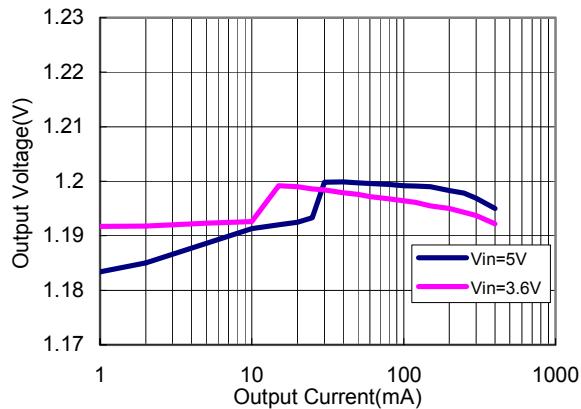
Symbol	Item	Condition	Min.	Typ.	Max.	Unit
VIN	Operating Input Voltage		2.55		5.50	V
VOUT	Step-down Output Voltage	VIN=VCE=3.6V or VSET+1V VOUT≥1.6V VOUT<1.6V	-1.5% -0.024		+1.5% 0.024	V
ΔVOUT/ΔT	Step-down Output Voltage Temperature Coefficient	-40°C≤TOPT≤85°C		±100		ppm/°C
FOSC	Oscillator Frequency	VIN=VCE=3.6V or VSET+1V	-20%	1.2	+20%	MHz
ISS1	Supply Current 1	VIN=VCE=5.5V, VOUT=0		400	500	μA
ISS2	Supply Current 2	VIN=VCE=5.5V, VOUT=5.5V		100	160	μA
ISTB	Standby Current	VIN=5.5V, VCE=0V		0	5	μA
ICEH	CE "H" Input Current	VIN=VCE=5.5V	-1	0	1	μA
ICEL	CE "L" Input Current	VIN=5.5V, VCE=0V	-1	0	1	μA
IVOUTH	VOUT "H" Input Current	VIN=VOUT=5.5V, VCE=0V	-1	0	1	μA
IVOUTL	VOUT "L" Input Current	VIN=5.5V, VCE=VOUT=0V	-1	0	1	μA
ILXLEAKH	Lx Leakage Current "H"	VIN=VLx=5.5V, VCE=0V	-1	0	5	μA
ILXLEAKL	Lx Leakage Current "L"	VIN=5.5V, VCE=VLx=0V	-5	0	1	μA
VCEH	CE "H" Input Voltage	VIN=5.5V	1.0			V
VCEL	CE "L" Input Voltage	VIN=5.5V			0.4	V
RONP	On Resistance of Pch Tr.	ILx=-100mA		0.5		Ω
RONN	On Resistance of Nch Tr.	ILx=-100mA		0.5		Ω
Maxdty	Max Duty Ratio		100			%
TSTART	Soft-start Time	VIN=VCE=3.6V or VSET+1V		120	150	μs
ILXLIM	Lx Current Limit	VIN=VCE=3.6V or VSET+1V	600	900		mA
TPROT	Protection Delay Time	VIN=VCE=3.6V or VSET+1V	0.5	1.5	5.0	ms
VUVLO1	UVLO Detector Voltage	VIN=VCE	2.1	2.2	2.3	V
VUVLO2	UVLO Released Voltage	VIN=VCE	2.2	2.3	2.4	V

*) Test circuit is "OPEN LOOP" and VIN=VCE=3.6V or VSET+1V, AGND=PGND=0V unless otherwise noted.

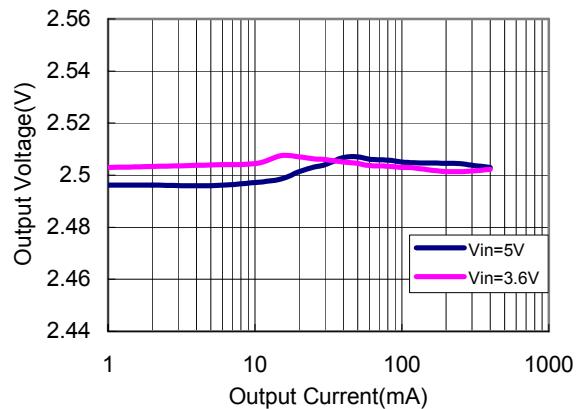
TYPICAL CHARACTERISTICS

1) Output Voltage vs. Output Current

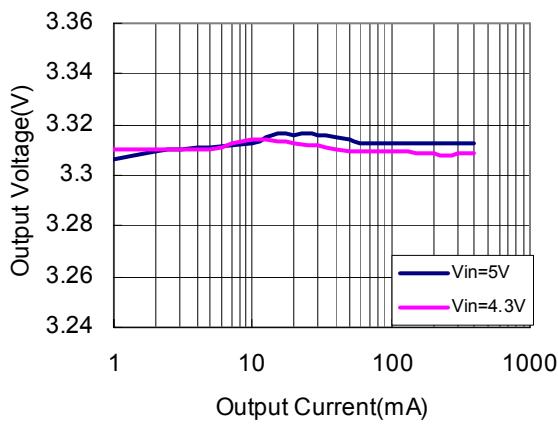
RP500X121A



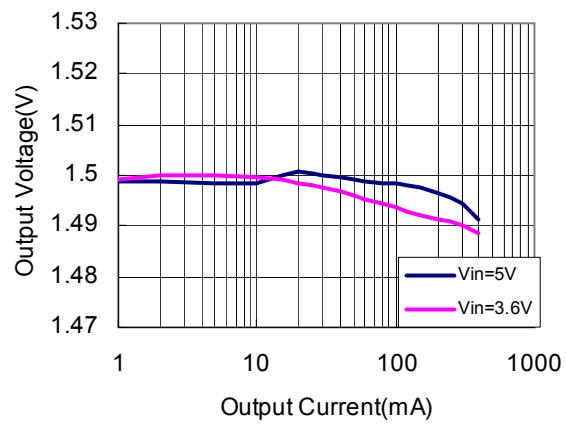
RP500X251A



RP500X331A

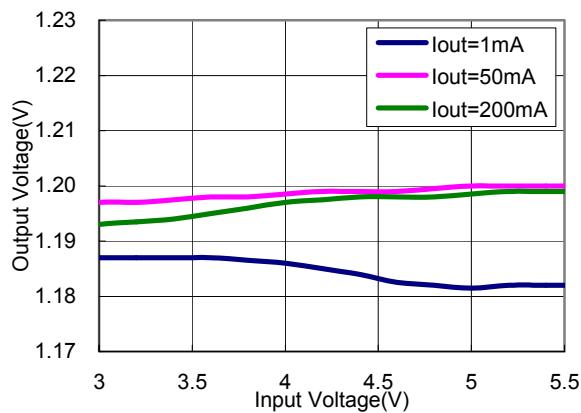


RP500X152A

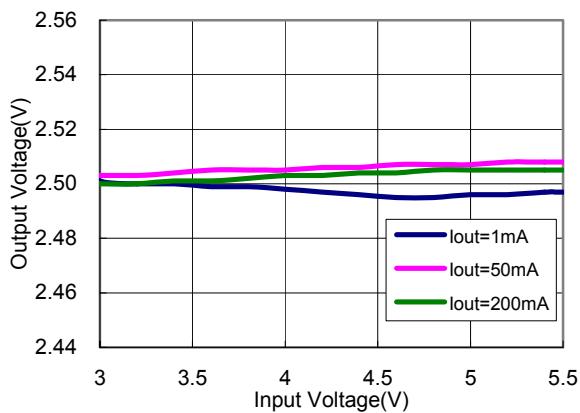


2) Output Voltage vs. Input Voltage

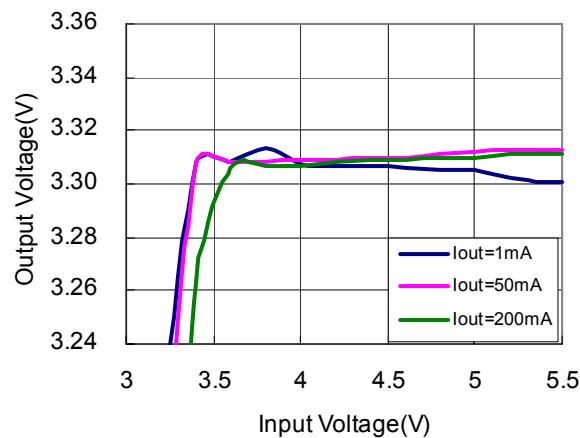
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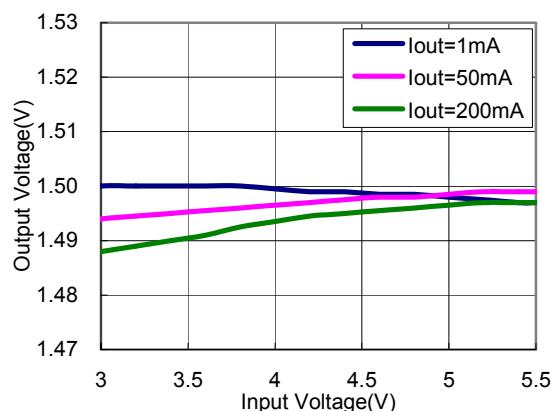
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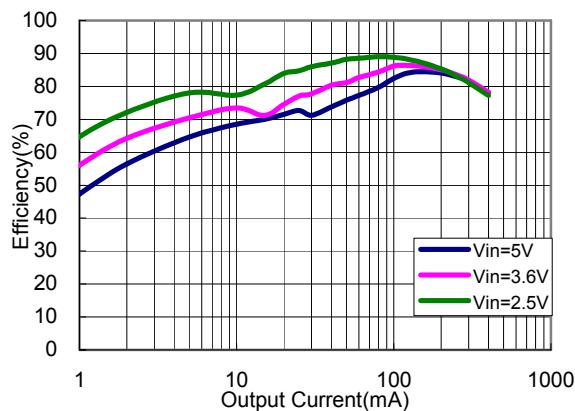


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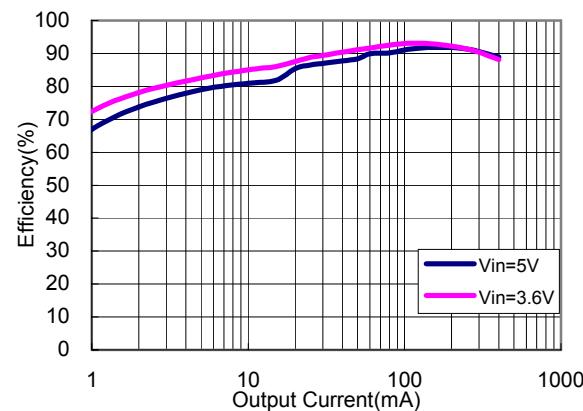


3) Efficiency vs. Output Current

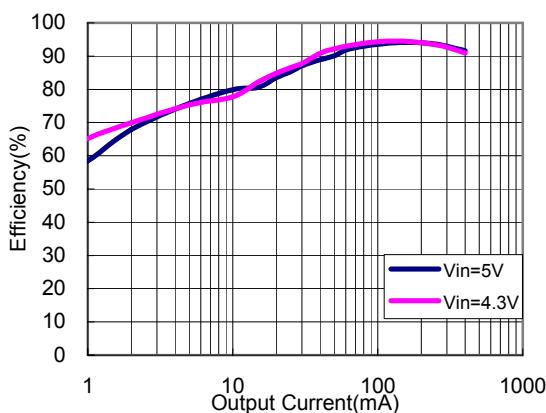
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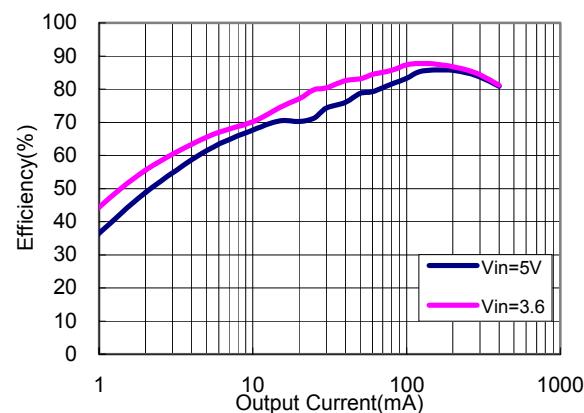
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RP500X331A



RP500X152A

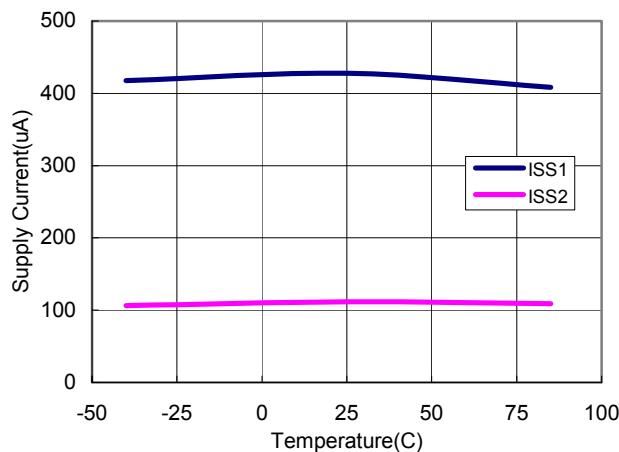


RP500X

4) Supply Current 1, 2 vs. Temperature

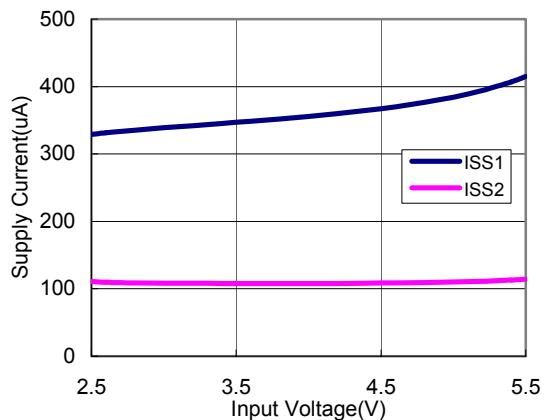
RP500X151A

$V_{IN}=V_{CE}=5.5V$



5) Supply Current 1,2 vs. Input Voltage

RP500X151A

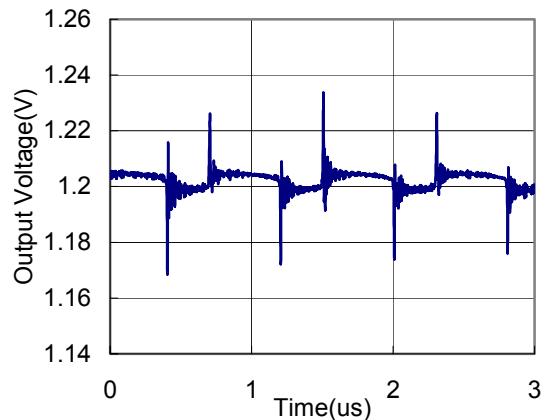
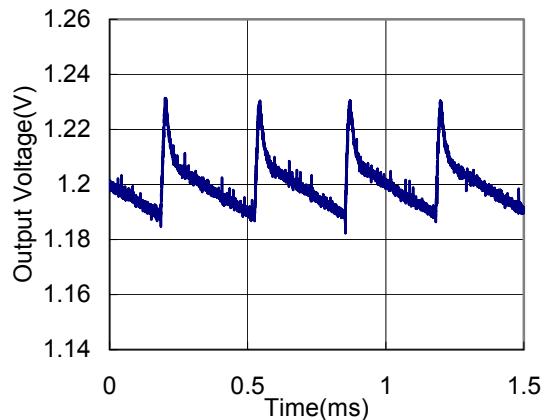


6) DC/DC Output Waveform

RP500X121A $C_{IN}=C_{OUT}=\text{Ceramic } 10\mu F$, $L=4.7\mu H$

$I_{OUT}=1mA$

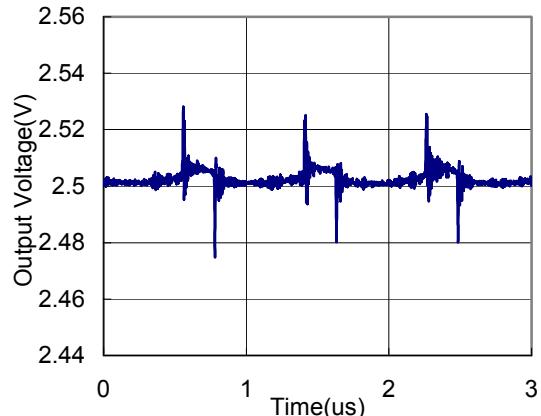
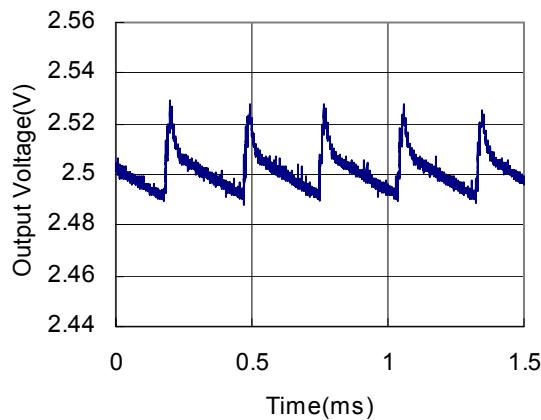
$I_{OUT}=200mA$



RP500X251A $C_{IN}=C_{OUT}=\text{Ceramic } 10\mu F$, $L=4.7\mu H$

$I_{OUT}=1mA$

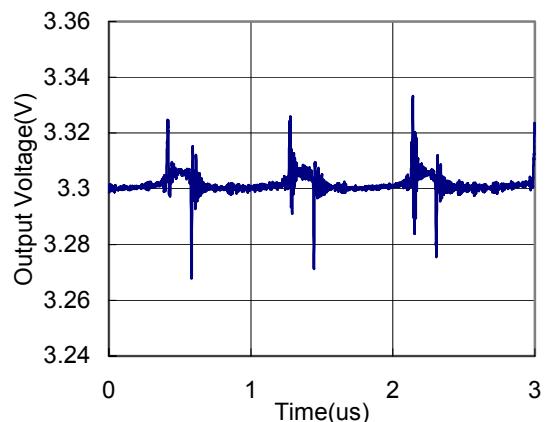
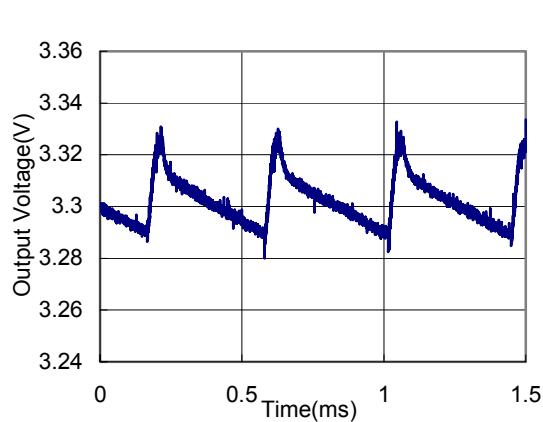
$I_{OUT}=200mA$



RP500X331A CIN=COUT=Ceramic10uF, L=4.7uH

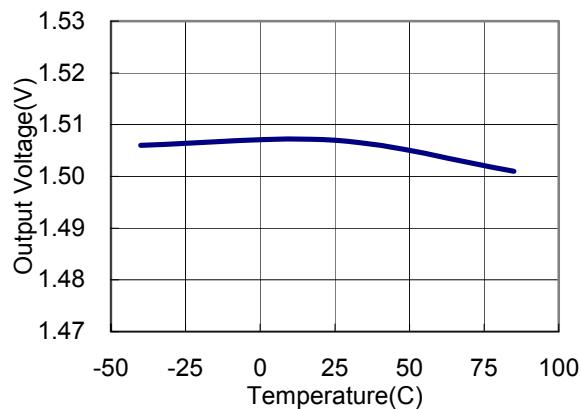
I_{OUT}=1mA

I_{OUT}=200mA

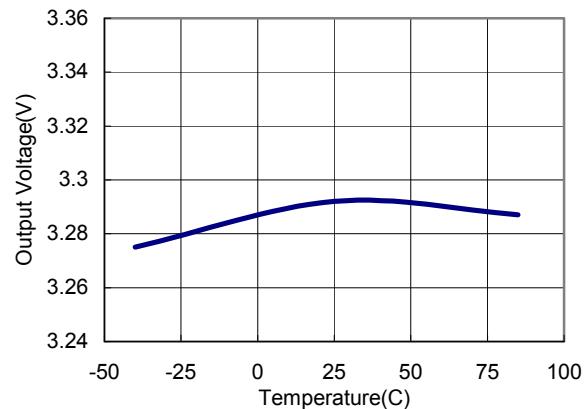


7) Output Voltage vs. Temperature

RP500X151A

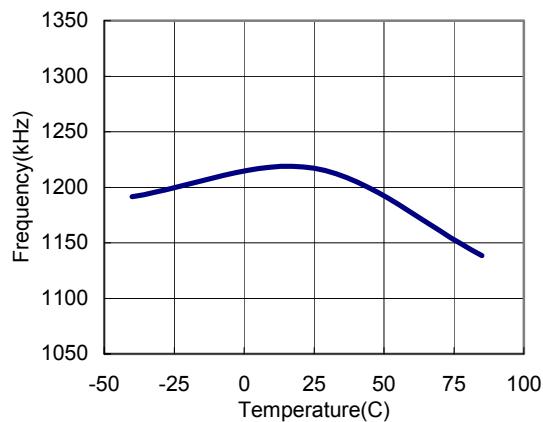


RP500X331A

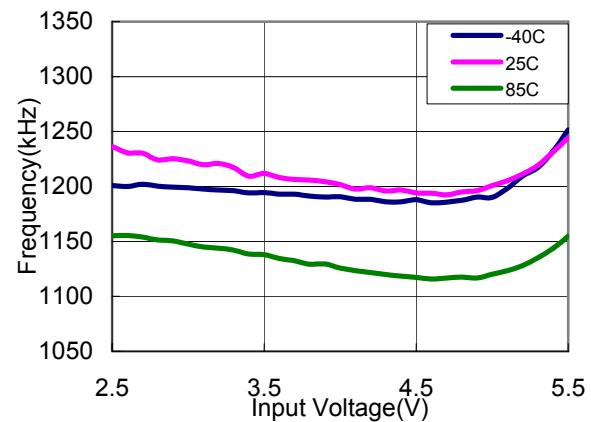


8) Oscillator Frequency vs. Temperature

V_{IN}=3.6V

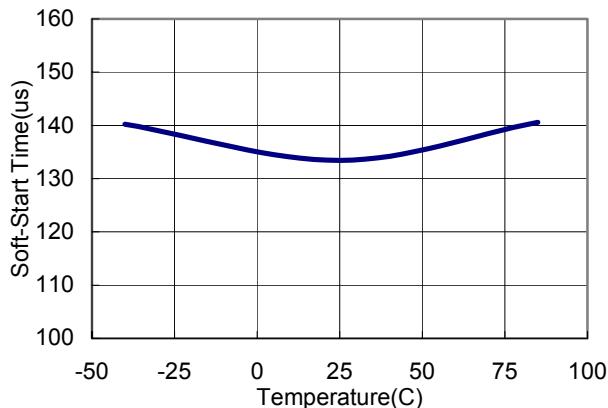


9) Oscillator Frequency vs. Input Voltage

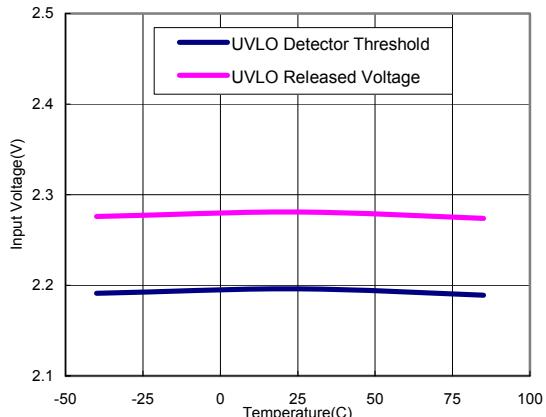


RP500X

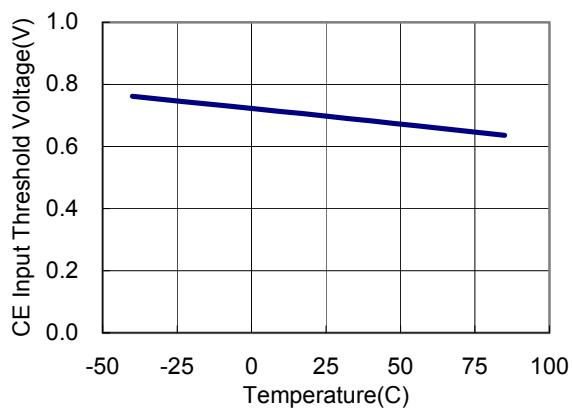
10) Soft-start Time vs. Temperature



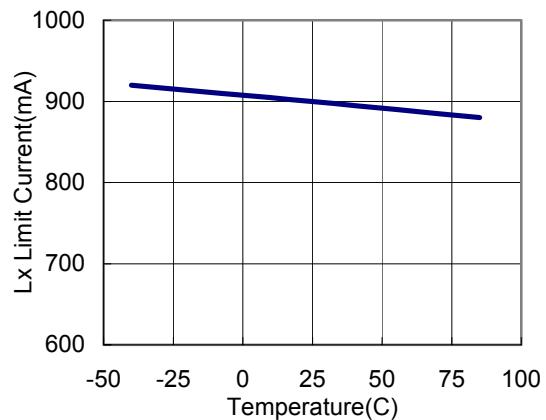
11) UVLO Detector threshold/Released Voltage vs. Temperature



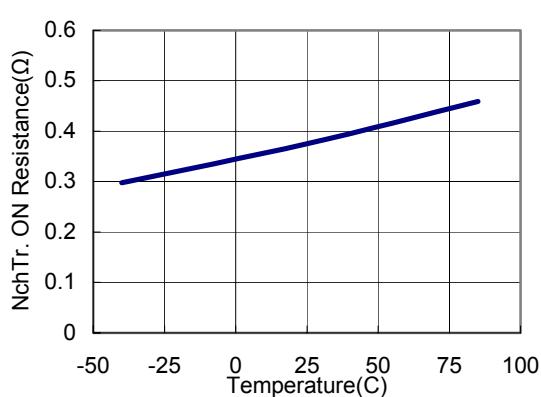
12) CE Input Threshold Voltage vs. Temperature



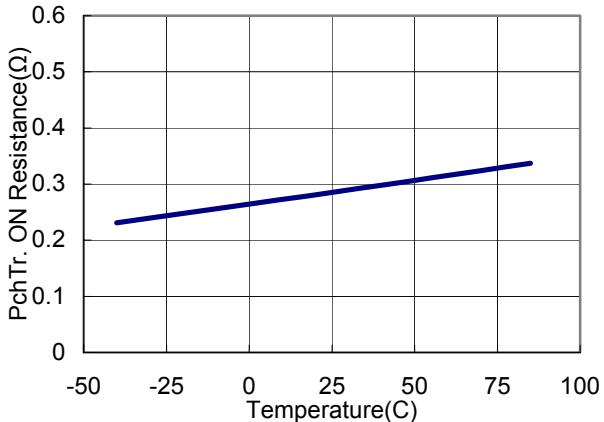
13) Lx Current Limit vs. Temperature



14) Nch Transistor On Resistance vs. Temperature

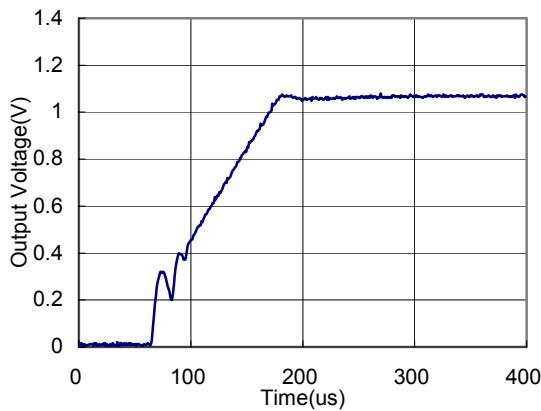
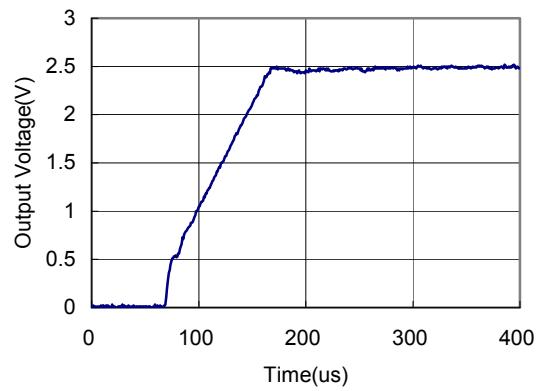
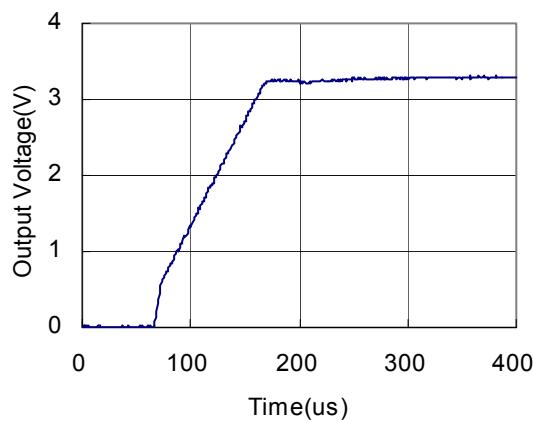
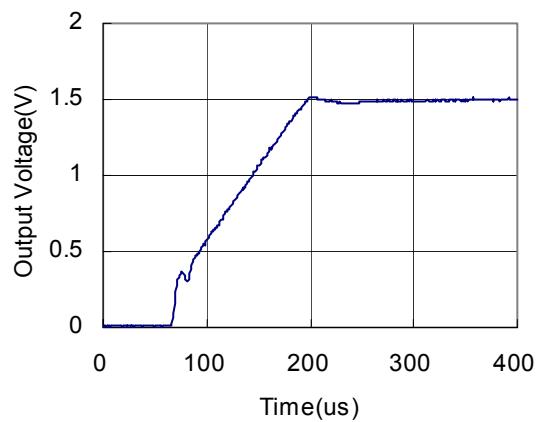
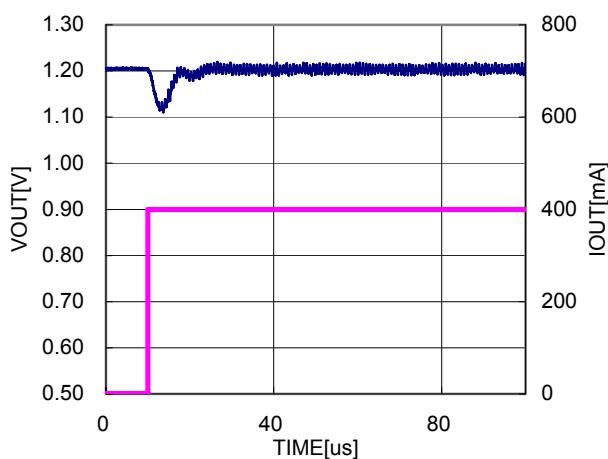


15) Pch Transistor On Resistance vs. Temperature



16) Turn-on Waveform

CIN=COUT=Ceramic10uF, L=4.7uH

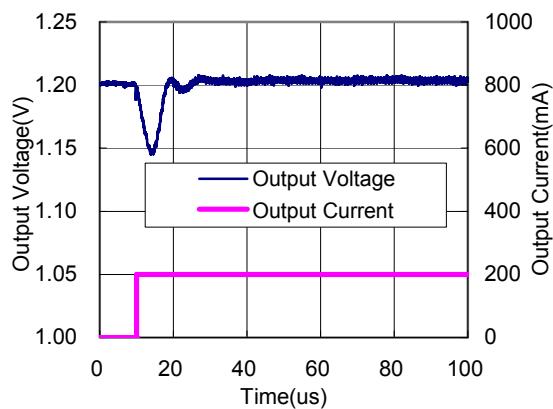
RP500X111A**RP500X251A****RP500X331A****RP500X152A****17) Load Transient Response ($T_r=T_f=1\mu s$)**RP500X121X $V_{in}=3.6V$, $I_{out}=0mA$ to $400mA$ 

RP500X

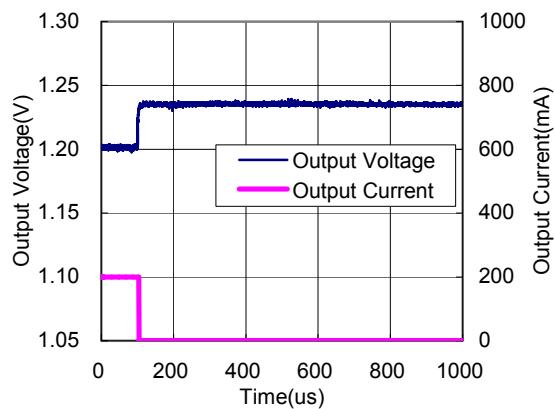
RP500X121A

$C_{IN}=C_{OUT}=\text{Ceramic } 10\mu\text{F}$, $L=4.7\mu\text{H}$, $V_{IN}=3.6\text{V}$

$I_{OUT}=0\text{mA}$ to 200mA



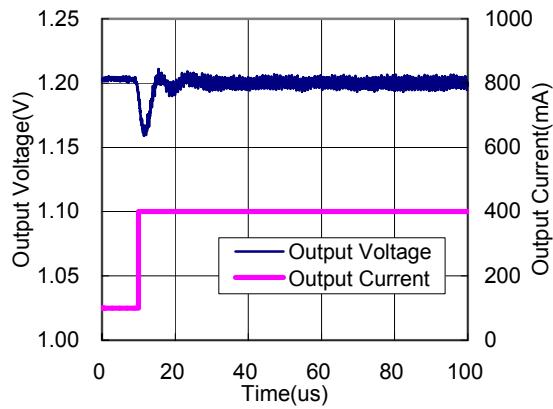
$I_{OUT}=200\text{mA}$ to 0mA



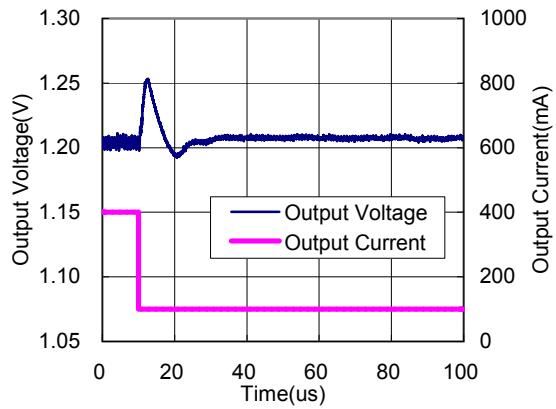
RP500X121A

$C_{IN}=C_{OUT}=\text{Ceramic } 10\mu\text{F}$, $L=4.7\mu\text{H}$, $V_{IN}=3.6\text{V}$

$I_{OUT}=100\text{mA}$ to 400mA

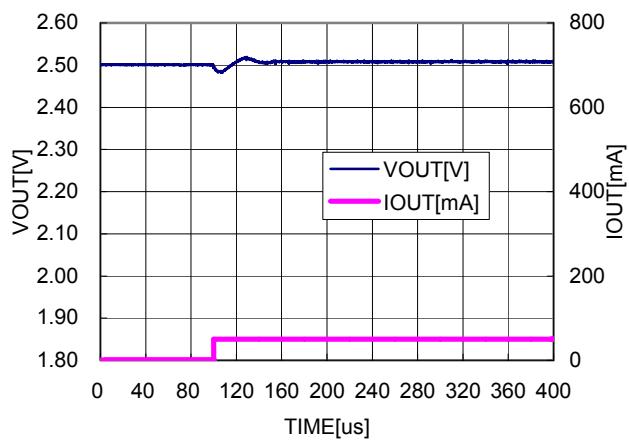


$I_{OUT}=400\text{mA}$ to 100mA



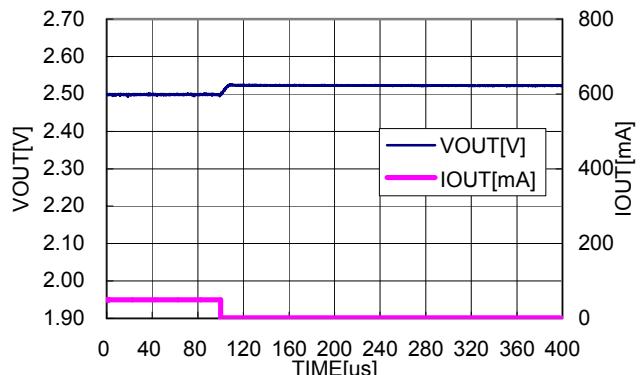
RP500X251X $V_{in}=5\text{V}$, $I_{out}=0$ to 50mA

RP500K251A

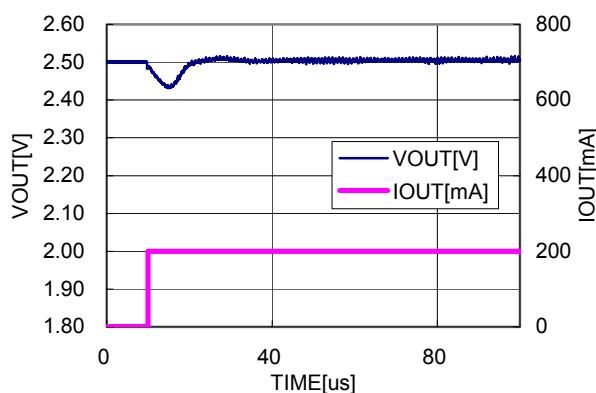


RP500X251X $V_{in}=5\text{V}$, $I_{out}=50\text{mA}$ to 0mA

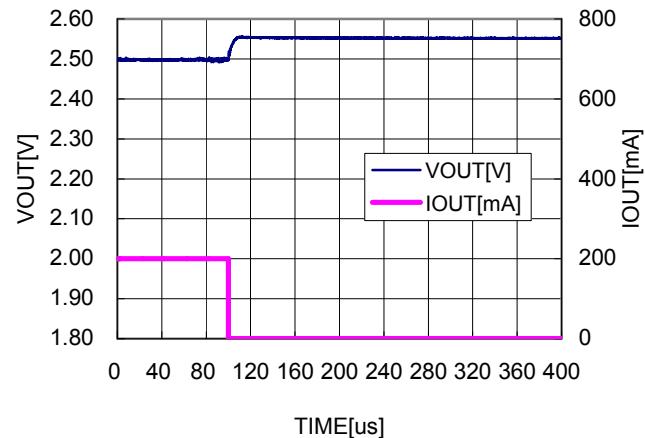
RP500K251A



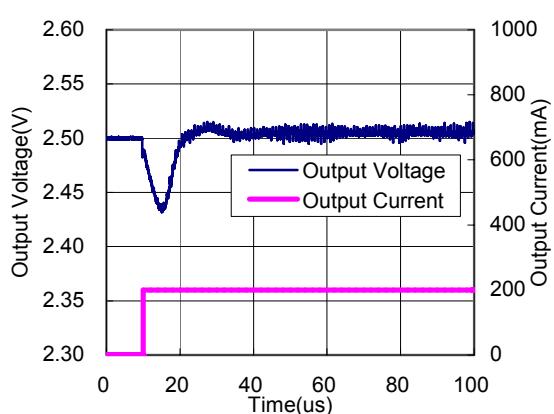
RP500X251X Vin=5V, Iout=0 to 200mA



RP500X251X Vin=5V, Iout=200mA to 0mA

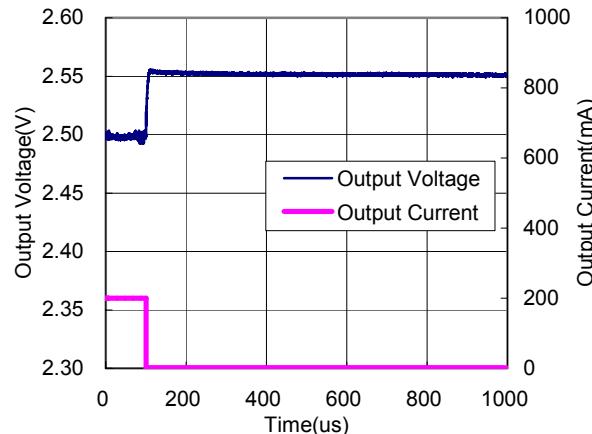


Iout=0mA to 200mA

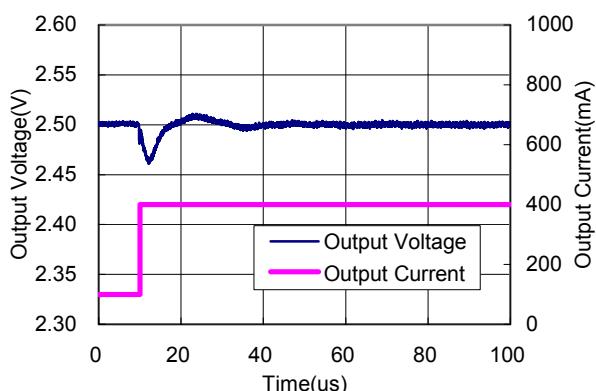


CIN=COUT=Ceramic10uF, L=4.7uH,VIN=5.0 V

Iout=200mA to 0mA



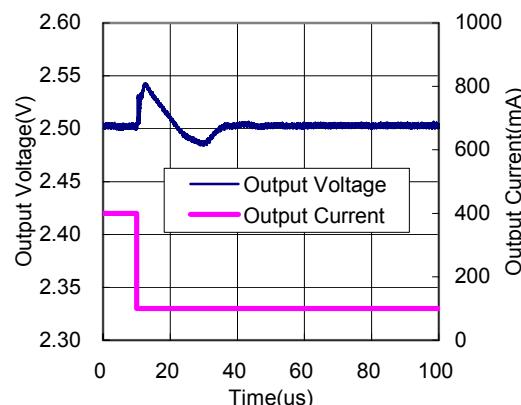
Iout=100mA to 400mA



RP500X251A

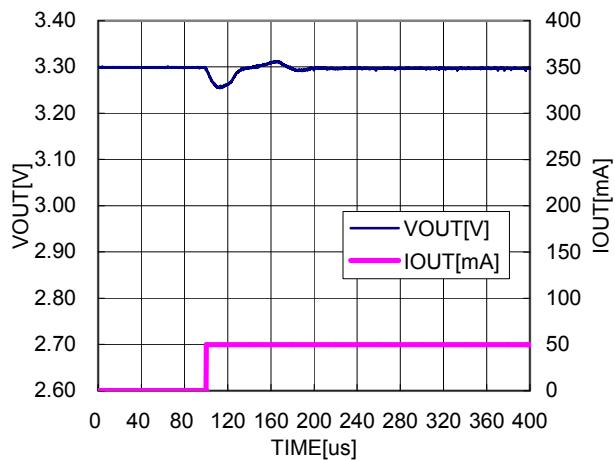
CIN=COUT=Ceramic10uF, L=4.7uH,VIN=5.0 V

Iout=400mA to 100mA

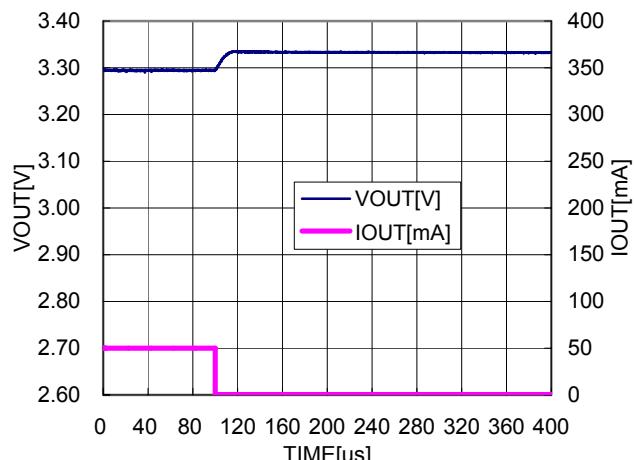


RP500X

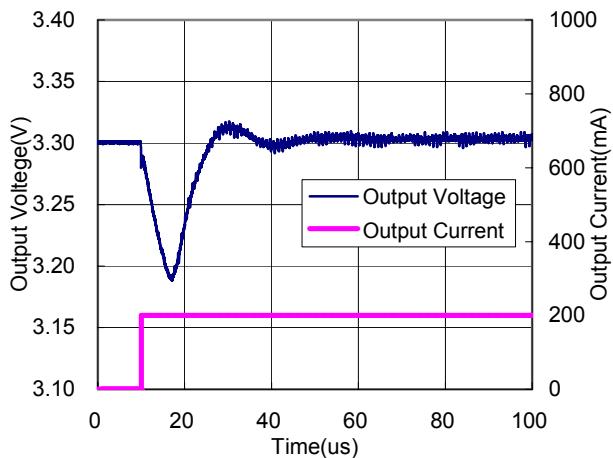
RP500X331X Vin=5V, Iout=0mA to 50mA



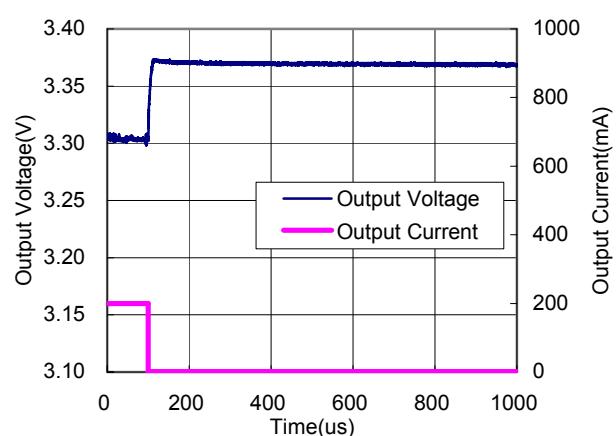
RP500X331X Vin=5V, Iout=50mA to 0mA



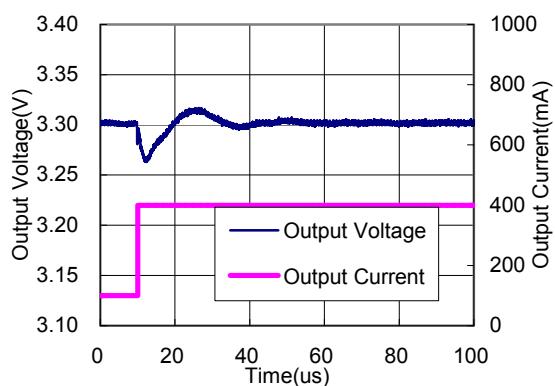
RP500X331A $C_{IN}=C_{OUT}=\text{Ceramic } 10\mu\text{F}$, $L=4.7\mu\text{H}$, $V_{IN}=5.0\text{ V}$
Iout=0mA to 200mA



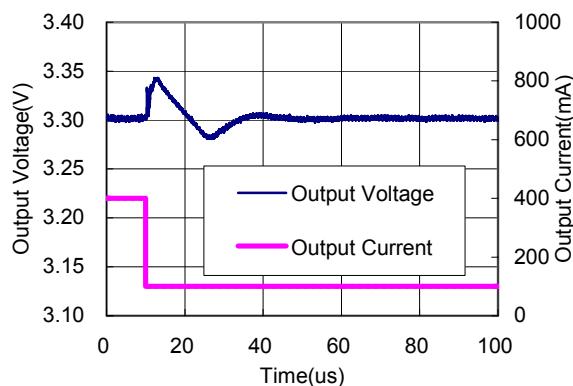
Iout=200mA to 0mA



RP500X331A $C_{IN}=C_{OUT}=\text{Ceramic } 10\mu\text{F}$, $L=4.7\mu\text{H}$, $V_{IN}=5.0\text{ V}$
Iout=100mA to 400mA

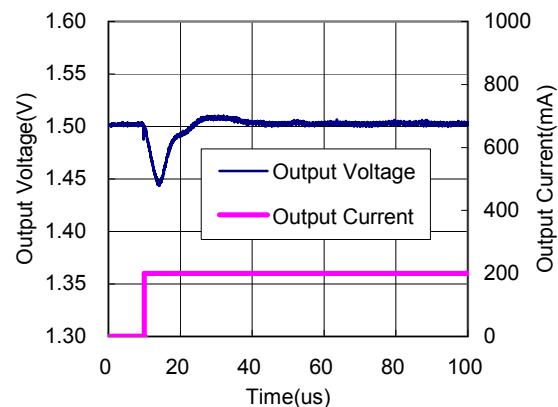
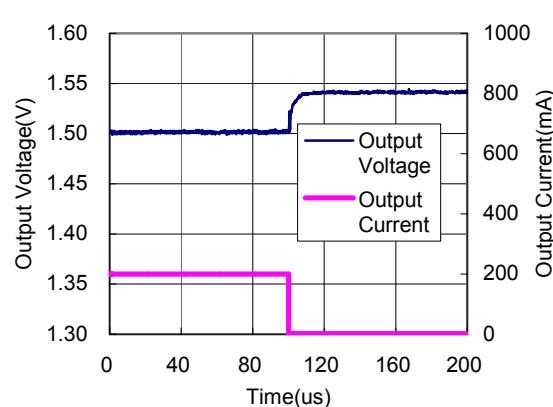


Iout=400mA to 100mA

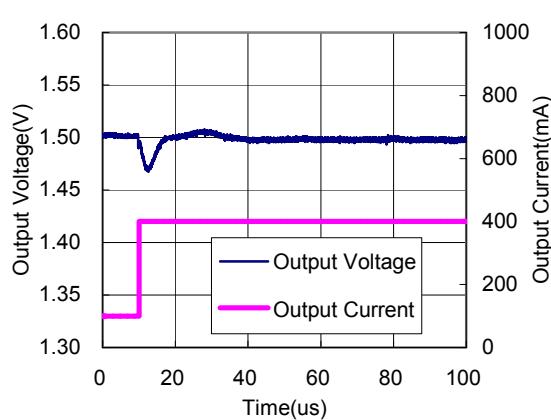
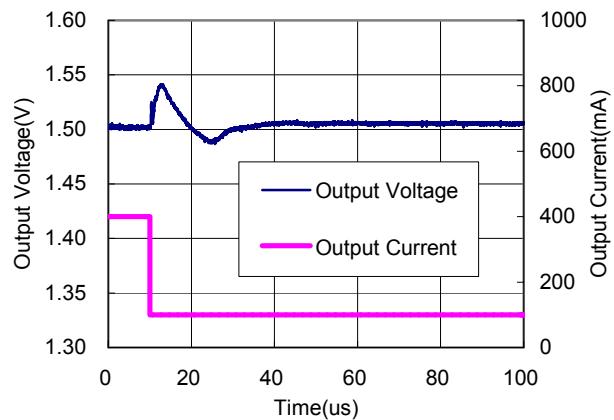


RP500X152A

CIN=COUT=Ceramic10uF, L=4.7uH, VIN=3.6V

I_{OUT}=0mA to 200mAI_{OUT}=200mA to 0mA**RP500X152A**

CIN=COUT=Ceramic10uF, L=4.7uH, VIN=3.6V

I_{OUT}=100mA to 400mAI_{OUT}=400mA to 100mA

RP500X

TYPICAL APPLICATION

External Components

CIN	10 μ F (Ceramic)
COUT	10 μ F (for 1.2MHz type)
L	4.7 μ H (for 1.2MHz type)

